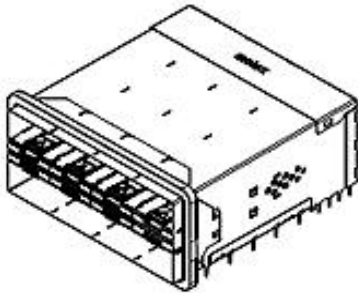




Part Number : [1700718001](#)
Product Description : zSFP+ Stacked Ganged Assembly with Elastomeric Gasket, 2-by-8 No Light Pipes, 320 Circuits
Series Number : 170071
Status : Active
Product Category : High-Speed I/O Connectors



Documents and Resources

Drawings

[1700718001_sd.pdf](#)

3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

[EE-170071-0001-001.pdf](#)

[SP-170426-1000-001.zip](#)

Specifications

[AS-170071-0002-001.pdf](#)

[PS-170071-0001-001.pdf](#)

[TS-170071-0001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)

EU RoHS	Compliant per EU 2015/863
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Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	High-Speed I/O Connectors
Series	170071
Description	zSFP+ Stacked Ganged Assembly with Elastomeric Gasket, 2-by-8 No Light Pipes, 320 Circuits
Application	Module-to-Board
Component Type	Receptacle
Product Name	zSFP Plus,zSFP+
Type	N/A
UPC	884982402355

Agency

UL	E29179
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Electrical

Current - Maximum per Contact	0.5A
Data Rate	28.0 Gbps

Shielded	Yes
Shield Type	N/A
Voltage - Maximum	30V AC

Physical

Circuits (Loaded)	320
Color - Resin	Black
Durability (mating cycles max)	100
Flammability	94V-0
Gender	Female
Lock to Mating Part	Yes
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Matte Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	159.679/g
Number of Rows	2
Orientation	Right Angle
Packaging Type	Tray
Panel Mount	No
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	2.36mm
Pitch - Mating Interface	0.80mm
Pitch - Termination Interface	0.80mm
Plating min - Mating	0.762μm
Plating min - Termination	0.762μm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	16
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Through Hole - Compliant Pin

Solder Process Data

Lead-Free Process Capability	N/A
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Application Tooling

This document was generated on Feb 26, 2026